



# SSRP130B1

Application Specific Discretes  
A.S.D.<sup>TM</sup>

## DUAL ASYMMETRICAL OVERVOLTAGE PROTECTION FOR TELECOM LINE

### MAIN APPLICATIONS

Where asymmetrical protection against lightning strikes and other transient overvoltages is required :

- Solid-State relays
- SLIC with integrated ring generator

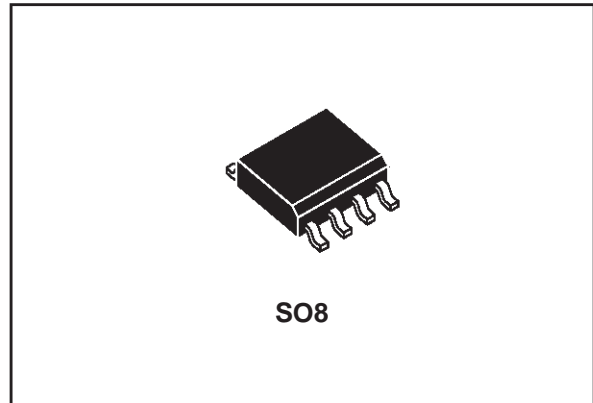
### DESCRIPTION

The SSRP130B1 is a dual asymmetrical transient voltage suppressor designed to protect a solid-state ring relay or SLICs with integrated ring generator from overvoltages.

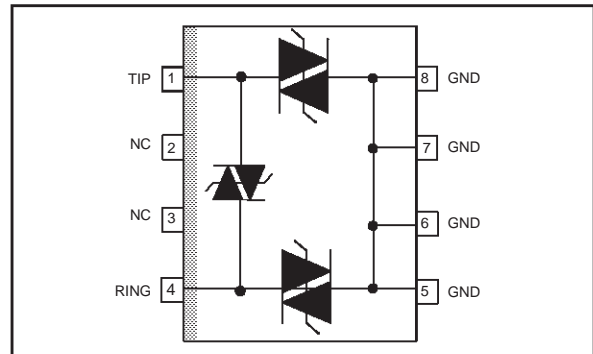
The asymmetrical protection configuration is necessary to allow the use of all different types of ringing schemes.

### FEATURES

- Dual bidirectional asymmetrical protection :  
Stand-off voltages :  
+ 130V for positive voltages  
- 185V for negative voltages
- Peak pulse current :  $I_{PP} = 2 * 25A$  (5 / 310  $\mu s$ )
- Holding current : 150mA



### FUNCTIONAL DIAGRAM



| COMPLIES WITH THE FOLLOWING STANDARDS: | Peak Surge Voltage (V) | Voltage Waveform ( $\mu s$ ) | Current Waveform ( $\mu s$ ) | Admissible $I_{pp}$ (A) | Necessary Resistor ( $\Omega$ ) |
|--|------------------------|------------------------------|------------------------------|-------------------------|---------------------------------|
| ITU-T K20                              | 1000                   | 10/700                       | 5/310                        | 25                      | -                               |
| VDE0433                                | 2000                   | 10/700                       | 5/310                        | 25                      | 40                              |
| VDE0878                                | 1500                   | 1.2/50                       | 1/20                         | 35                      | 3                               |
| IEC 1000-4-5                           | Level 2                | 10/700<br>1.2/50             | 5/310<br>8/20                | 25<br>25                | -<br>-                          |
| FCC Part 68                            | 1500<br>800            | 10/160<br>10/560             | 10/160<br>10/560             | 29<br>21                | 45<br>30                        |
| BELLCORE TR-NWT-001089                 | 2500<br>1000           | 2/10<br>10/1000              | 2/10<br>10/1000              | 70<br>15                | 30<br>57                        |

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APPLICATION INFORMATION

Fig 1 : Topology of the classical line card protection.

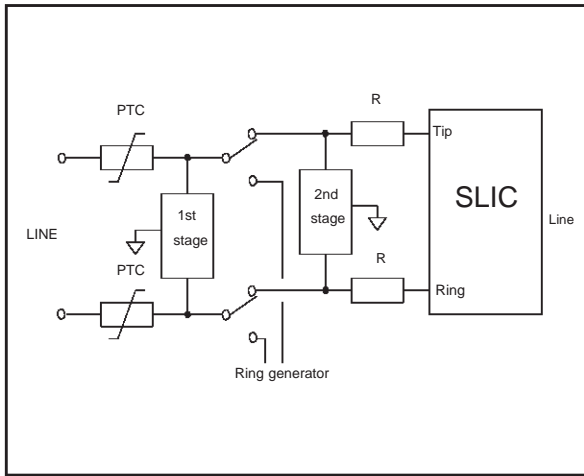
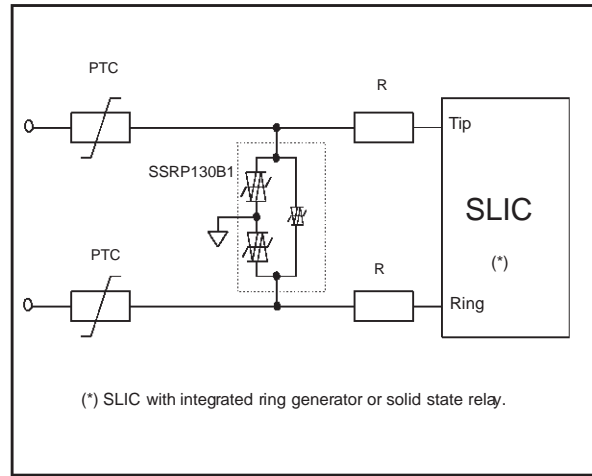


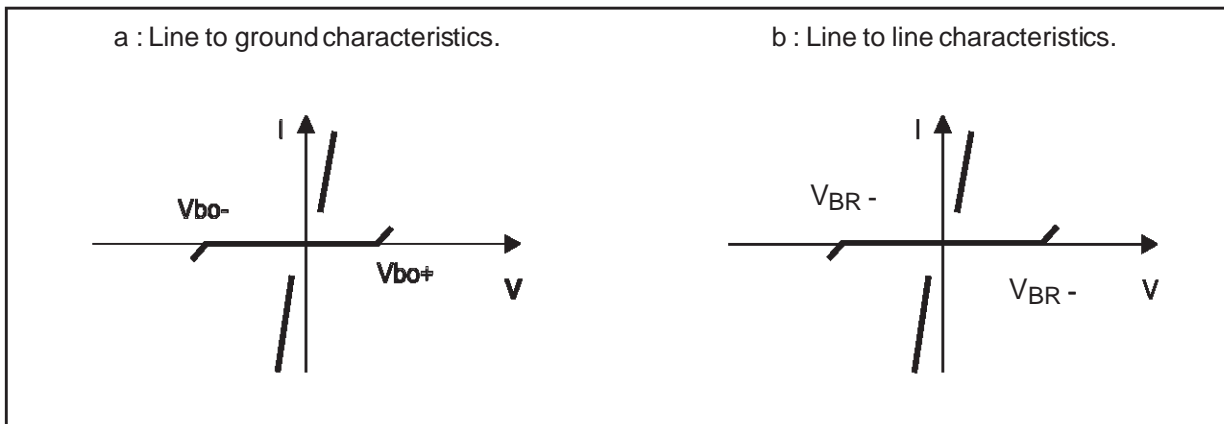
Fig 2 : Classical use of the SSRP130B1.



The classical line card requires protection before the ring relay and a second one for the SLIC (fig.1). The use of new SLICs with integrated ring generator or board based on solid state ring relay suppresses this second protection (Fig. 2). Then the only remaining stage, located between the line and the ring relay, has to optimize the protection. The classical symmetrical first stage protector becomes not sufficient to avoid any circuit destruction during surges.

The SSRP130B1 device takes into account this fact and is based on asymmetrical voltage characteristics (Fig.3a). The ring signal being shifted back by the battery voltage, the SSRP130B1 negative breakover value  $V_{bo-}$  is greater than the positive one  $V_{bo+}$ . This point guarantees a protection operation very close to the peak of the normal operating voltage without any disturbance of the ring signal.

Fig3 : SSRP130B1 electrical characteristics.



In addition with the 2 crowbar functions which perform the protection of both TIP and RING lines versus ground, a third cell assumes the differential mode protection of the SLIC. The breakdown voltage values of this third cell are the same for

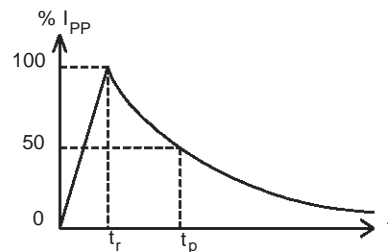
both positive and negative parts of the characteristics and are equivalent to the negative breakdown voltage value of the TIP and RING lines versus GND cells (Fig.3 b).

**ABSOLUTE MAXIMUM RATINGS** ( $T_{amb} = 25^{\circ}\text{C}$ )

| Symbol             | Parameter   | Value  | Unit                                     |
|--------------------|---|--|--|
| $I_{PP}$           | Peak pulse current (see note 1)                                     | 10/1000 $\mu\text{s}$<br>5/310 $\mu\text{s}$<br>1/20 $\mu\text{s}$<br>2/10 $\mu\text{s}$ | 2x15<br>2x25<br>2x35<br>2x70<br>A        |
| $I_{TSM}$          | Non repetitive surge peak on-state current (F=50Hz)                 | $t_p = 0.2 \text{ s}$<br>$t_p = 5 \text{ s}$<br>$t_p = 900 \text{ s}$                    | 7.5<br>4.0<br>1.5<br>A                   |
| $T_{op}$           | Operating temperature range   | 0 to + 70  | $^{\circ}\text{C}$                       |
| $T_{stg}$<br>$T_j$ | Storage temperature range<br>Maximum operating junction temperature | - 55 to + 150<br>+ 150   | $^{\circ}\text{C}$<br>$^{\circ}\text{C}$ |
| $T_L$              | Maximum lead temperature for soldering during 10s                   | 260  | $^{\circ}\text{C}$                       |

Note 1 : Pulse waveform :

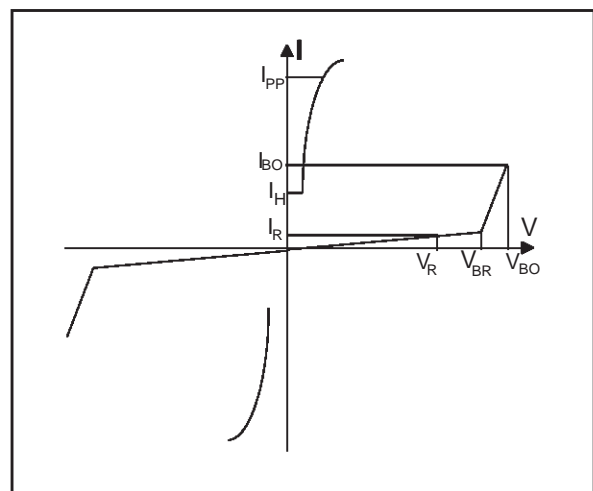
|                       |                        |                          |
|-----------------------|------------------------|--------------------------|
| 10/1000 $\mu\text{s}$ | $t_r = 10 \mu\text{s}$ | $t_p = 1000 \mu\text{s}$ |
| 5/310 $\mu\text{s}$   | $t_r = 5 \mu\text{s}$  | $t_p = 310 \mu\text{s}$  |
| 1/20 $\mu\text{s}$    | $t_r = 1 \mu\text{s}$  | $t_p = 20 \mu\text{s}$   |
| 2/10 $\mu\text{s}$    | $t_r = 2 \mu\text{s}$  | $t_p = 10 \mu\text{s}$   |

**THERMAL RESISTANCE**

| Symbol        | Parameter           | Value | Unit                        |
|---------------|---------------------|-------|-----------------------------|
| $R_{th(j-a)}$ | Junction to ambient | 170   | $^{\circ}\text{C}/\text{W}$ |

**ELECTRICAL CHARACTERISTICS** ( $T_{amb} = 25^{\circ}\text{C}$ )

| Symbol   | Parameter                            |
|----------|--------------------------------------|
| $V_R$    | Stand-off voltage                    |
| $I_R$    | Leakage current at stand-off voltage |
| $V_{BR}$ | Breakdown voltage                    |
| $V_{BO}$ | Breakover voltage                    |
| $I_H$    | Holding current                      |
| $I_{BO}$ | Breakover current                    |
| $I_{PP}$ | Peak pulse current                   |
| C        | Capacitance                          |



## SSRP130B1

### ELECTRICAL CHARACTERISTICS between TIP and GND, RING and GND ( $T_{amb}=25^{\circ}\text{C}$ )

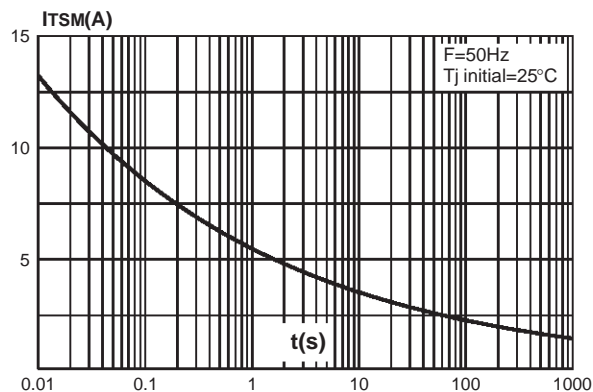
| Symbol   | Parameter                  | Test conditions (note 1)   | Min        | Max  | Unit          |
|----------|----------------------------|--|------------|--|---------------|
| $V_{BO}$ | Breakover voltage (note 2) | Positive voltage<br>50Hz<br>10/700 $\mu\text{s}$<br>1.2/50 $\mu\text{s}$<br>2/10 $\mu\text{s}$<br><br>Negative voltage<br>50Hz<br>10/700 $\mu\text{s}$<br>1.2/50 $\mu\text{s}$<br>2/10 $\mu\text{s}$ |            | 200<br>175<br>180<br>250<br><br>280<br>235<br>240<br>340 | V             |
| $I_{BO}$ | Breakover current          | Positive voltage<br>Negative voltage   | 110<br>110 |  | mA            |
| $I_H$    | Holding current            | Positive polarity<br>Negative polarity   | 150<br>150 |  | mA            |
| $I_R$    | Leakage current (note 3)   | $V_R = +130\text{ V}$<br>$V_R = -185\text{ V}$   |            | 10<br>10   | $\mu\text{A}$ |
| C        | Capacitance                | $F = 100\text{kHz}$ , $V = 100\text{mV}$ , $V_R = 0\text{V}$   |            | 100  | pF            |

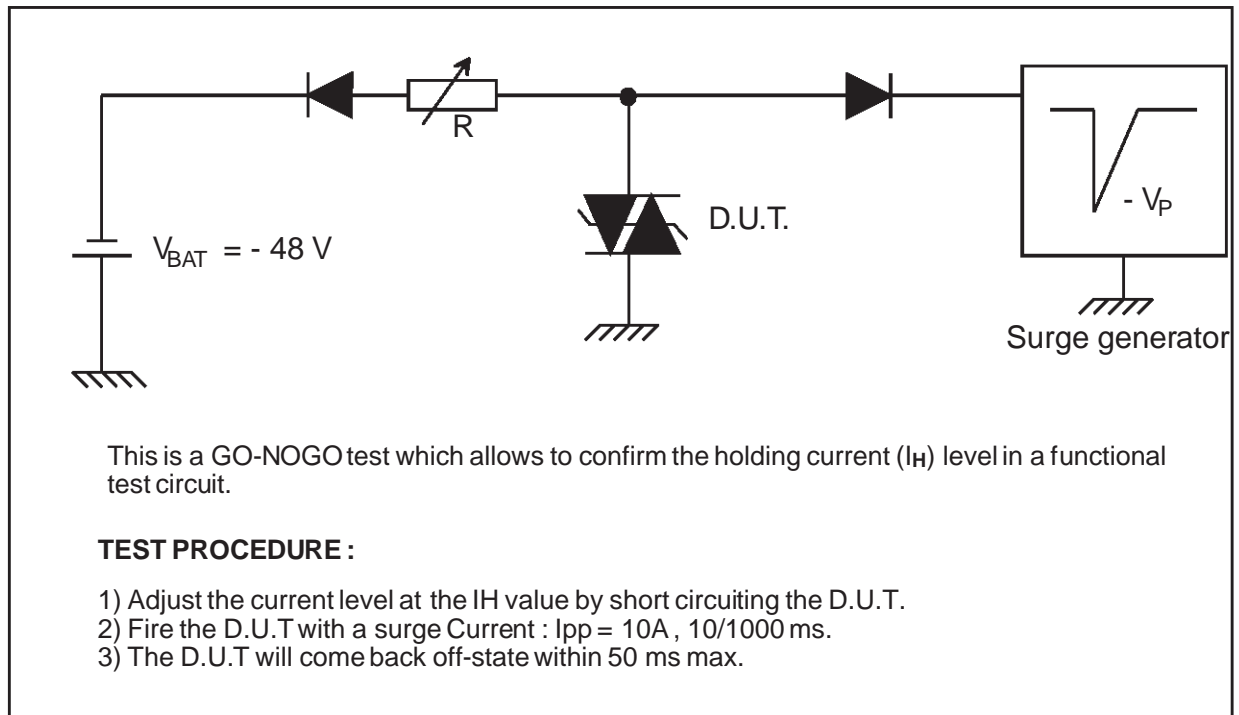
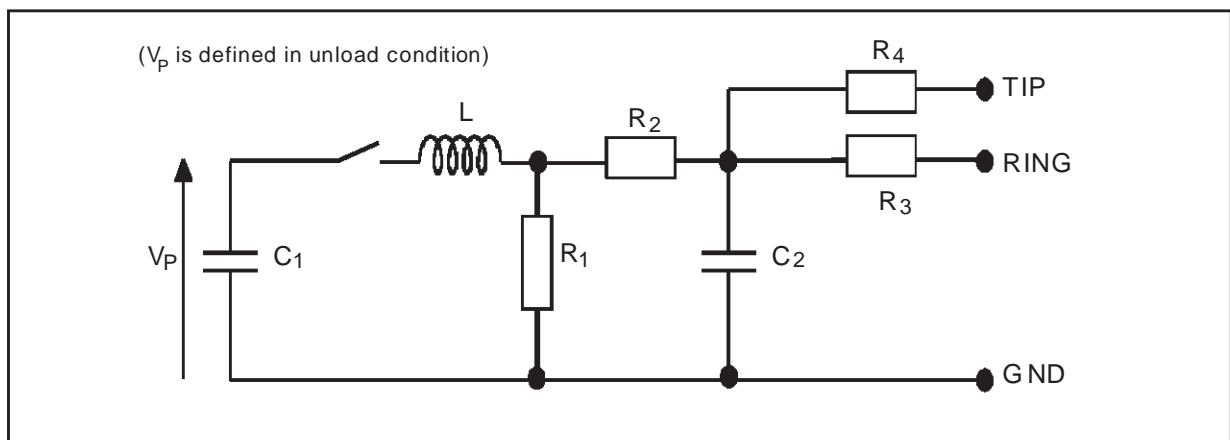
### ELECTRICAL CHARACTERISTICS between TIP and RING ( $T_{amb}=25^{\circ}\text{C}$ )

| Symbol | Parameter                | Test conditions  | Min | Max      | Unit          |
|--------|--------------------------|--|-----|----------|---------------|
| $I_R$  | Leakage current (note 3) | $V_R = +185\text{ V}$<br>$V_R = -185\text{ V}$               |     | 10<br>10 | $\mu\text{A}$ |
| C      | Capacitance              | $F = 100\text{kHz}$ , $V = 100\text{mV}$ , $V_R = 0\text{V}$ |     | 100      | pF            |

- Note 1 : Positive voltage means between T and G, or between R and G  
Negative voltage means between G and T, or between G and R  
Note 2 : See test circuit for  $V_{BO}$  parameters  
Note 3 :  $I_R$  measured at  $V_R$  guarantees  $V_{BR} > V_R$

**Fig. 4** : Surge peak current versus overload duration (maximum values).

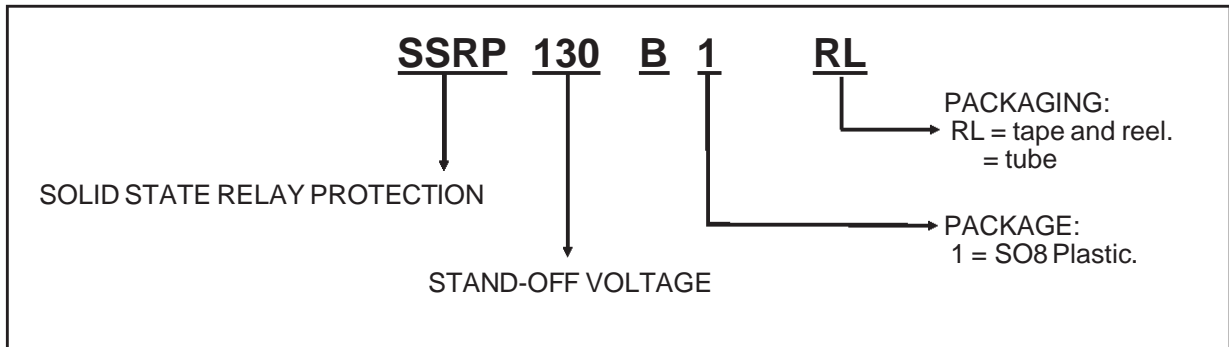


FUNCTION HOLDING CURRENT ( $I_H$ ) TEST CIRCUIT (GO-NO GO TEST)TEST CIRCUIT FOR  $V_{BO}$  parameters:

| Pulse ( $\mu s$ ) |       | $V_p$<br>(V) | $C_1$<br>( $\mu F$ ) | $C_2$<br>(nF) | $L$<br>( $\mu H$ ) | $R_1$<br>( $\Omega$ ) | $R_2$<br>( $\Omega$ ) | $R_3$<br>( $\Omega$ ) | $R_4$<br>( $\Omega$ ) | $I_{PP}$<br>(A) | $R_p$<br>( $\Omega$ ) |
|-------------------|-------|--------------|----------------------|---------------|--------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------|-----------------------|
| $t_r$             | $t_p$ |              |                      |               |                    |                       |                       |                       |                       |                 |                       |
| 10                | 700   | 1000         | 20                   | 200           | 0                  | 50                    | 15                    | 25                    | 25                    | 25              | 0                     |
| 1.2               | 50    | 1500         | 1                    | 33            | 0                  | 76                    | 13                    | 25                    | 25                    | 30              | 10                    |
| 2                 | 10    | 2500         | 10                   | 0             | 1.1                | 1.3                   | 0                     | 3                     | 3                     | 38              | 62                    |

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## ORDER CODE

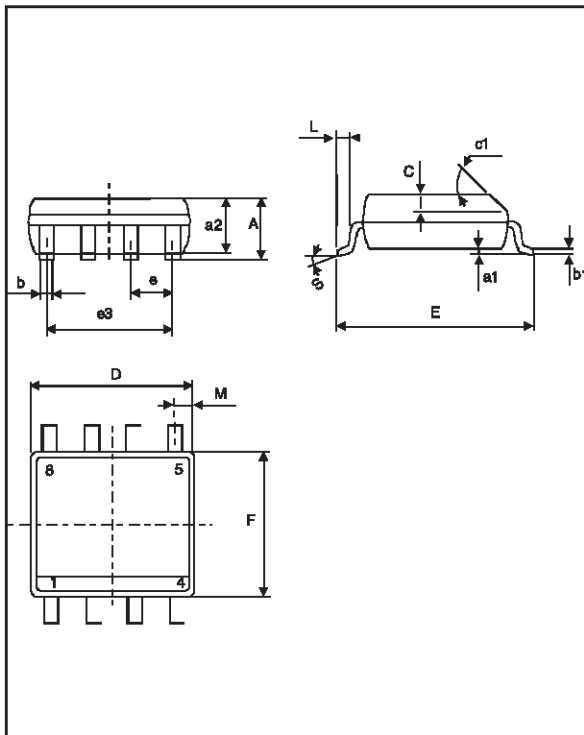


## MARKING

| Types     | Package | Marking |
|-----------|---------|---------|
| SSRP130B1 | SO8     | SSR130  |

## PACKAGE MECHANICAL DATA. SO8 Plastic

**MARKING** : Logo, Date Code, Part Number.



| REF. | DIMENSIONS  |      |      |        |       |       |
|------|-------------|------|------|--------|-------|-------|
|      | Millimetres |      |      | Inches |       |       |
|      | Min.        | Typ. | Max. | Min.   | Typ.  | Max.  |
| A    |             |      | 1.75 |        |       | 0.069 |
| a1   | 0.1         |      | 0.25 | 0.004  |       | 0.010 |
| a2   |             |      | 1.65 |        |       | 0.065 |
| b    | 0.35        |      | 0.48 | 0.014  |       | 0.019 |
| b1   | 0.19        |      | 0.25 | 0.007  |       | 0.010 |
| C    |             | 0.50 |      |        | 0.020 |       |
| c1   | 45° (typ)   |      |      |        |       |       |
| D    | 4.8         |      | 5.0  | 0.189  |       | 0.197 |
| E    | 5.8         |      | 6.2  | 0.228  |       | 0.244 |
| e    |             | 1.27 |      |        | 0.050 |       |
| e3   |             | 3.81 |      |        | 0.150 |       |
| F    | 3.8         |      | 4.0  | 0.15   |       | 0.157 |
| L    | 0.4         |      | 1.27 | 0.016  |       | 0.050 |
| M    |             |      | 0.6  |        |       | 0.024 |
| S    | 8° (max)    |      |      |        |       |       |

**Packaging** : Products supplied in antistatic tubes or tape and reel.

**Weight** : 0.08g

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